

Attorney Docket No. 061063-0317066
Client Reference: OSP-18862

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: **AKIRA OKUBO, HIDEYUKI KONDO**

Application No.:

Confirmation

No:

Filed: August 1, 2005

Group No.:

Examiner

For: **INSPECTION METHOD, MANUFACTURING METHOD OF PIECE FOR ANALYSIS,
ANALYSIS METHOD, ANALYZER, MANUFACTURING METHOD OF SOI WAFER,
AND SOI WAFER**

**Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**

**APPLICATION DATA SHEET
37 C.F.R. § 1.76**

BIBLIOGRAPHIC DATA

1. Applicant information

First applicant: **AKIRA OKUBO**
Citizenship: **JAPAN**
Residence: **Tokyo, JAPAN**

Second applicant: **HIDEYUKI KONDO**
Citizenship: **JAPAN**
Residence: **Tokyo, JAPAN**

2. Correspondence information

Correspondence for this application should be addressed as follows:

Customer No.: 00909

3. Application information

Title of Invention: **INSPECTION METHOD, MANUFACTURING METHOD OF PIECE FOR
ANALYSIS, ANALYSIS METHOD, ANALYZER, MANUFACTURING METHOD OF SOI
WAFER, AND SOI WAFER**

Docket number assigned to this application: 061063-0317066

Suggested Classification:

Class:

Subclass:

Technology Center to which subject matter is assigned:

Total number of drawing sheets: 7
Type of application: Utility
Application is to be published. Suggested drawing figure for publication:

Secrecy order under § 5.2:

This application does not disclose subject matter of an application which is under a secrecy order pursuant to § 5.2.

4. Representative information

The following have a power of attorney or authorization of agent in this application:

Customer No.: 00909

5. Domestic Priority information

Domestic priority for this application is claimed as follows:

35 U.S.C. § 365(c):
Application No.: PCT/JP2003/013271
Filed: October 16, 2003
Status: Pending
Relationship: Parent

6. Foreign priority information

Foreign priority is claimed for this application as follows:

Country: JAPAN
Application No.: 2003-026540
Filing Date: February 3, 2003
Status: Pending

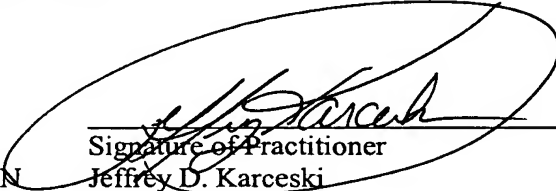
7. Assignee information

The assignee(s) of this application is/are:

Sumitomo Mitsubishi Silicon Corporation
2-1, Shibaura 1-chome, Minato-ku
Tokyo,
JAPAN
Extent of interest of assignee in application: 100%

Date: August 1, 2005

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